

Instrumentation Challenges at future h-h colliders

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Hadron-hadron colliders: past present and future

Detector design: physics goals & rate/radiation limitations

Tracking detectors, HL-LHC and beyond?

Trigger – HL-LHC and beyond (needed or not?)

Calorimetry: maybe the future is here?

Muon detection & identification

Fast timing – a “holy grail” within reach

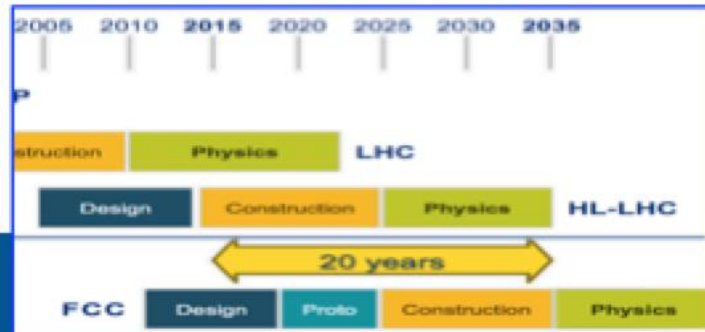
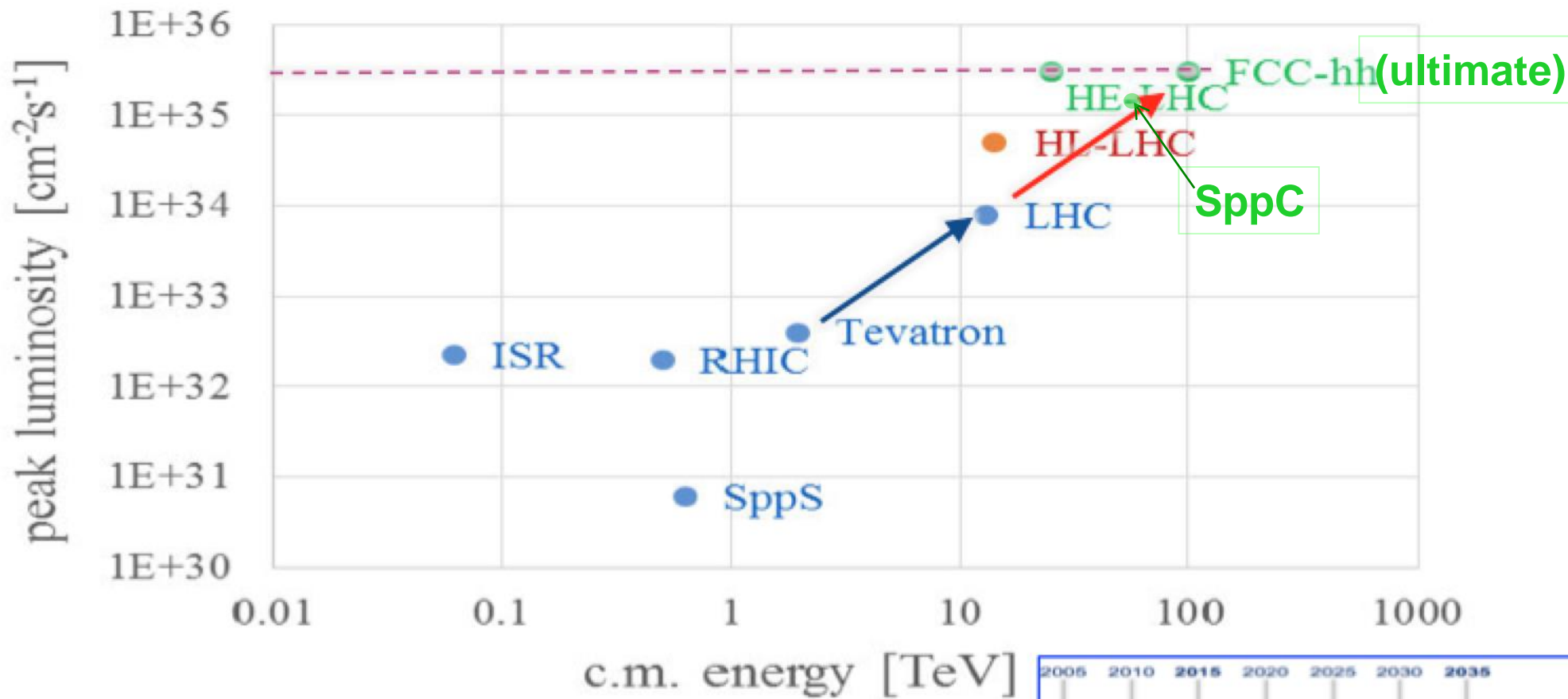
FCC-hh: detector design- starting with a blank page

Conclusions

Particular thanks to:

Phil Allport, Dave Barney, Didier Contardo, Albert de Roeck, Kevin Einsweiler, Werner Riegler, Frank Zimmermann

h-h Colliders: past, present & future



Future h-h colliders parameters

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Machine parameters (p-p) ---> event rate issues (approximate numbers)

	HL-LHC nominal	HL-LHC ultimate	HE-LHC	SPPC	FCC-hh Phase1	FCC-hh Phase 2
Collision energy	14	14	>25	71.2	100	100
Bunch spacing	25	25	25	25	25	25 (5)
Lumi x 10^{34}	5 (lev)	7.5 (lev)	>25	12	5	20-30
<Pileup>	140	200	850	400	170	1000 (200)

Remarks: FCC Phase1 : similar detector conditions to HL-LHC Phase 2 = ultimate)
HE-LHC and FCC- Phase 2 are a new scale of challenge

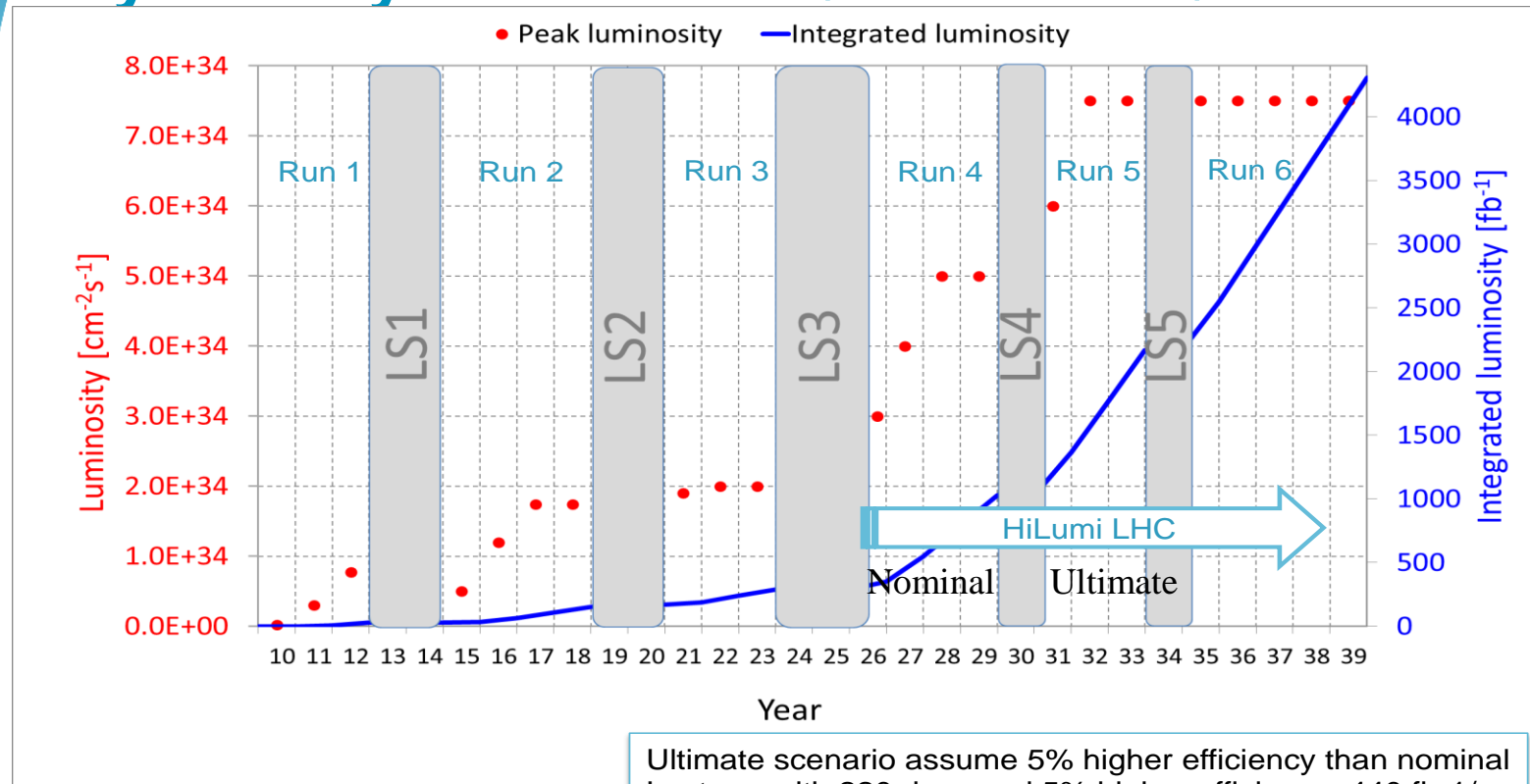
Future h-h colliders – HL-LHC

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& at ultimate performance sets the design challenge for detectors installed in LS3

Ultimate scenario $7.5 \cdot 10^{34}$: $320 \text{ fb}^{-1}/\text{y}$ for 160 days

Physics days: 160 Run4 → 200 Run5 → 220 Run6



Detector design: physics drivers

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- 1) **Higgs physics** remains a key objective -- until (hopefully) something else comes along,
 - > maintain acceptance, efficiency & resolution for decays of 125GeV Higgs (a light object)
 - boost due to higher E_{cm}
- 2) ...while simultaneously optimising search sensitivity for high mass discovery
 - > dynamic range challenge (eg muon trigger p_{T} thresholds)
- 3) **Forward processes, VBF, multi-Higgs etc.**
 - > extend acceptance (especially for jet reconstruction) to higher η

Basic Requirements:

Values quoted apply to FCC-hh or SppC

Precision tracking in magnetic field down to low p_{T}

Electromagnetic calorimetry to high η ($\eta=4$) [30-50% loss of H \rightarrow 4l wrt HL-LHC if stay at 2.5]

Matched tracking and highly granular calorimetry to high η ($\eta=6$) [measure VBF jets & separate from pileup]

Hermetic calorimetry: constant term (1-2%) & full shower containment (12λ depth) [di-jet mass res]

Good Momentum resolution at highest p_{T} (~10-15% at $p_{\text{T}}=10\text{TeV}$)

Fine granularity calorimetry (esp high η) to measure jet structure & reject pile-up (0.025x0.025)

Efficient charged track/neutral cluster association with vertex (r,z or r,z,t) for pile-up rejection

Efficient secondary vertex tagging (b,c, τ) despite radiation levels near luminous region

Detector design: rate & radiation tolerance

$$1\text{MeV neq Fluence}[cm^{-2}] \approx \frac{N_0}{2r[cm]^2\pi} \times N_{pp} \quad \text{Dose}[Gray] \approx 3.2 \times 10^{-10} \frac{N_0}{2r[cm]^2\pi} \times N_{pp}$$

For a given N_{pp} , both are functions only of distance from beampipe

- : ignoring effects of magnetic field**
- : considering only primary charged hadrons from pp collisions**
- valid up to $r \sim 10\text{cm}$, beyond that curling particles and neutron cloud**

---> For x 5 in lumi, feed in new technologies with better rad tolerance at low radius

Today's inner technology at LHC will likely still be in HL-LHC, but further out

Δ c.m energy (x7) does not change the radiation field that much

FCC- hh (nominal)

100mb inelastic pp crosssection (+25% cf HL-LHC)

$dN/d\eta = N_0 = 8$ (+50% cf HL-LHC)

for $3000 \text{ fb}^{-1} = 3 * 10^{17}$ events

a Pixel tracker layer1 at $r = 3.7\text{cm}$ will see

1MeVneq fluence = $3 * 10^{17} * 8 / (2 * \pi * 3.7^2) = 2.8 * 10^{16} \text{ cm}^{-2}$

Dose = $3.2 * 10^{-8} * 2.8 * 10^{16} = 9 \text{ MGy}$

FCC-hh Phase 1 detector sees $\sim 2 \times$ the HL-LHC detector fluence and dose

	HL-LHC 3000 fb ⁻¹	
	Outer layers	Innermost layer
Particle Rate (kHz/mm ²)	1000	10000
Fluence (n _{eq} /cm ²)	1 x 10 ¹⁵	2 x 10 ¹⁶
Dose in MGy	0.5	> 10

. HL-LHC solutions \sim OK for FCC-hh Phase 1, but not HE-LHC or FCC-hh Phase 2

Detector design: other factors

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For HL-LHC (and quite probably HE-LHC), one of the biggest challenges is to integrate new instrumentation into the original magnet and infrastructure and indeed a large fraction of the original detectors

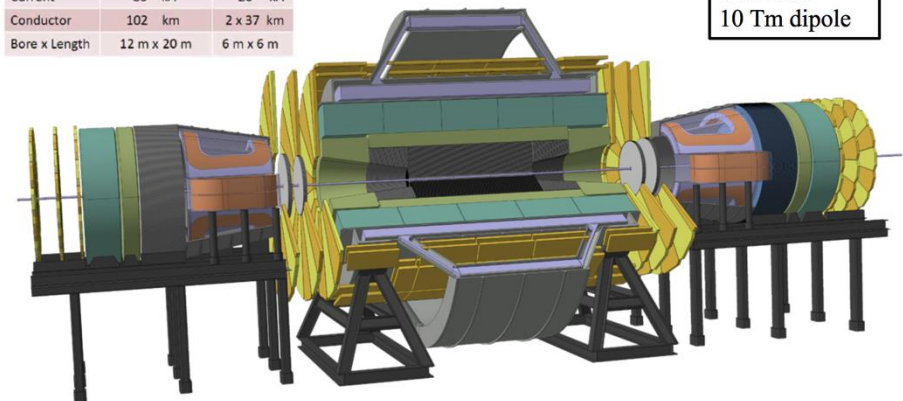


For FCC-hh, exciting to start with a blank sheet of paper, but the design

- a) won't work as a simple extrapolation of what we have today, evolved for HL-LHC.
- b) has to take into account from scratch all of the infrastructure/buildability/installability/ maintainability factors

	Twin Solenoid	Dipole
Stored energy	53 GJ	2 x 1.5 GJ
Total mass	6 kt	0.5 kt
Peak field	6.5 T	6.0 T
Current	80 kA	20 kA
Conductor	102 km	2 x 37 km
Bore x Length	12 m x 20 m	6 m x 6 m

Twin solenoid
6 Tesla
12m bore
10 Tm dipole



Tracking: Meeting the HL-LHC challenge

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Improve	Patt. Rec. at high pileup	Tracking efficiency	$\delta(1/pT)$ low PT	$\delta(1/pT)$ high PT	impact param & vertex resolution	2- track sep	$\gamma \rightarrow ee$ pollution
Granularity (high r)	●	●		●			
Granularity (low r)					●	●	
More pixelated layers	●				●		
Reduce X_0 's		●	●				●

Extension to $\eta=4$ to help reconstruct forward jets

permanent cooling (to combat radiation damage effects on sensor characteristics)

compact, radiation-hard, low cost optical & electrical links to export data

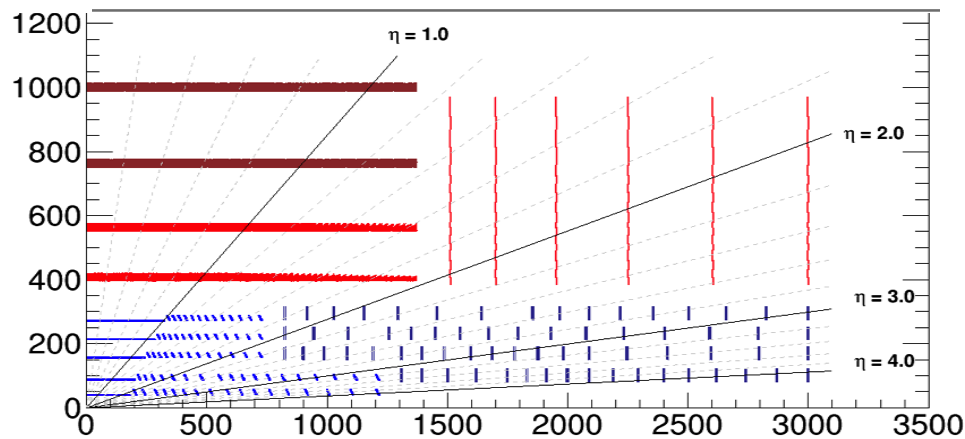
serial powering (very large numbers of channels running at low voltages

& drawing high currents \rightarrow big potential power loss in cables)

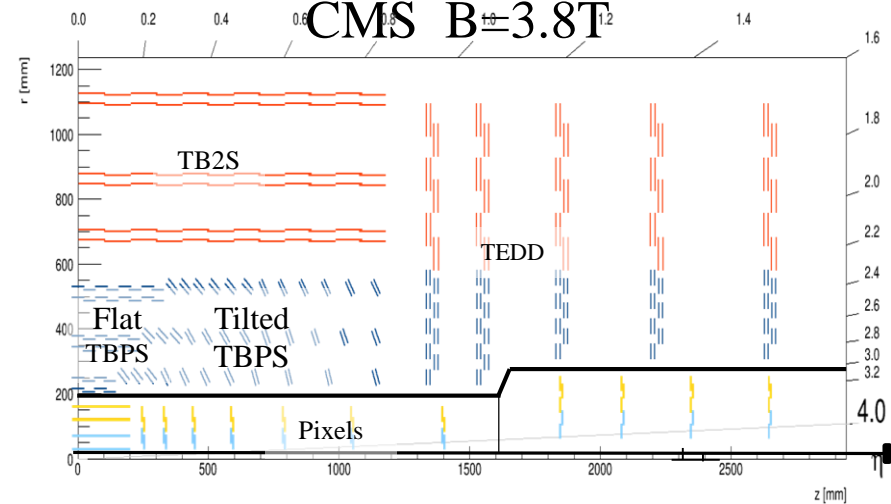
HL-LHC trackers.. Pre TDR

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ATLAS B=2T



CMS B=3.8T



All silicon : ~ 200 - 220 m² strips (similar CMS Tracker) + 10 - 20 m² pixels
 Pixels in 200 - 250 mm $< r < 30$ - 40 mm
 Extension to $\eta \sim 4$ (forward jets important)

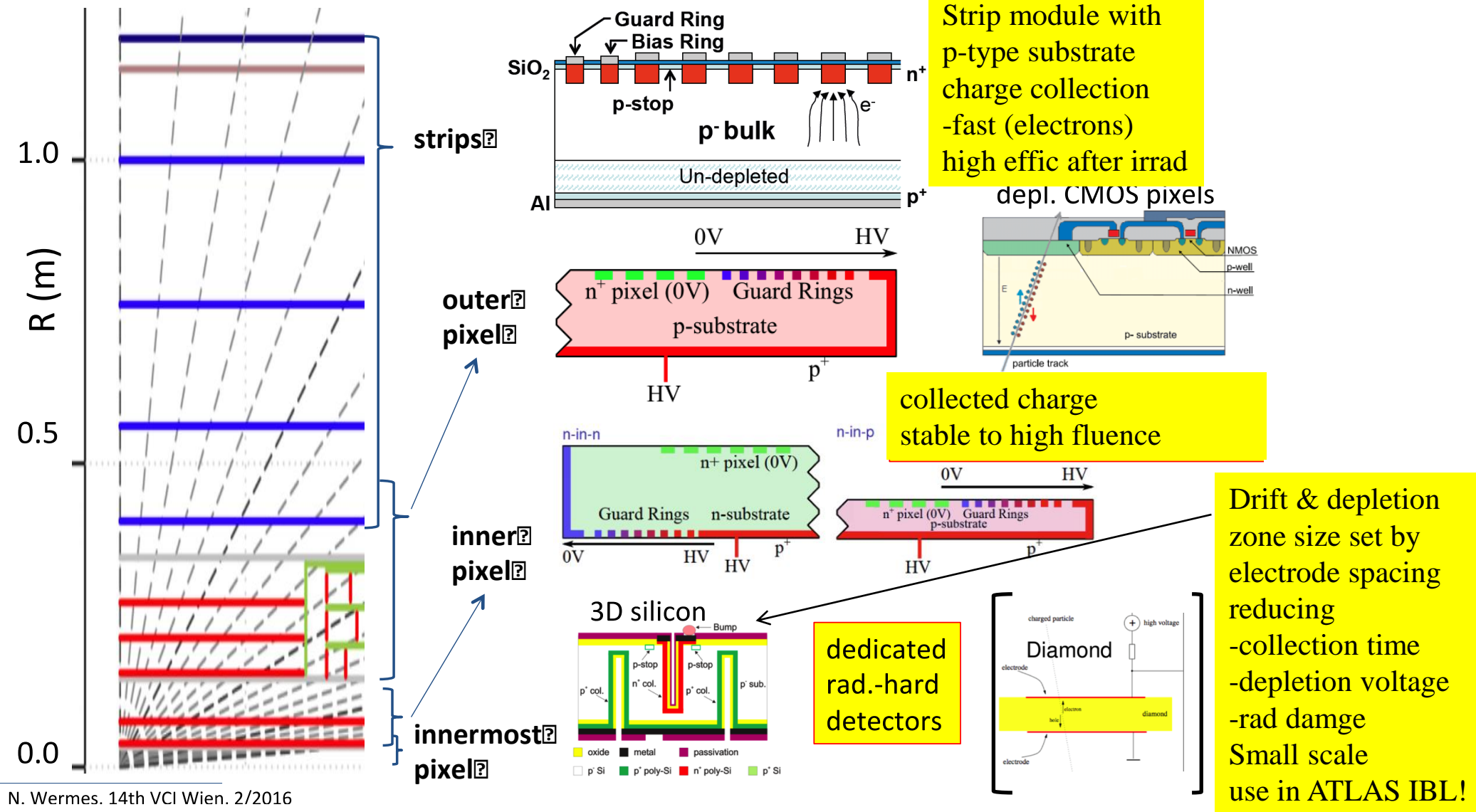
fine granularity consistent with expected occupancy

good spatial resolution + low material budget over long path length in magnetic field

tolerance of expected:- - hit and data rates

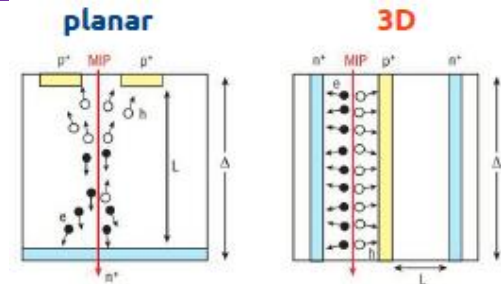
- radiation environment (dose rate & integrated dose),

HL_LHC trackers (pre TDR)



Tracking readout: challenges concentrate at low r

- Tests show **HL-LHC assault**: $2 \times 10^{16} n_{eq}/cm^2$, 10 MGy, pileup 200 can be withstood by the proposed inner layer sensor technologies
- 3-D Si sensors (drift orthogonal to ionisation track) are installed in ATLAS IBL – an excellent battle test.



Mechanisms leading to anomalously large signals mostly understood (& even exploited!)

Readout hopes focused on: common CMOS 65nm ASIC development by CERN RD53. (targeted at $50\mu m \times 50\mu m$ pixel sizes).

Hopefully 65nm is the magic bullet for HL-LHC as 250nm was at LHC. Many challenges met:

See eg Jorgen Christiansen & Maurice Garcia-Sciveres, LHCC May16

but

difficult problems, specific to 65nm remain, especially in radiation tolerance [RINCE,RISCE]

These are complex and make the choice of a qualification procedure and of appropriate design margins difficult, in particular for digital design

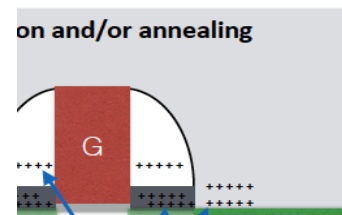
F. Faccio, ACES 2016

As was learned in the past,

radiation tolerance also varies between different fabrication facilities and can vary with time.

F. Faccio, TWEPP 2015

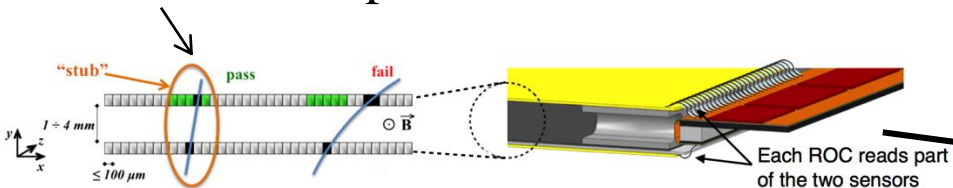
FE-13	FE-14	FE-65
hit rate < 100 MHz/cm ² < 100 Mrad	hit rate < 400 MHz/cm ² 1.8 mW/mm ² rad hard: 5x10 ¹⁵ /cm ² 200 Mrad	hit rate 2-3 GHz/cm ² < 1 MHz trigger @12μs 3.5 mW/mm ² rad hard: 2x10 ¹⁶ /cm ² 1 Grad
250 nm technology pixel size 400 × 50 μm ² 3.5 M. transistors	130 nm technology pixel size 250 × 50 μm ² 70 M transistors	65 nm technology pixel size 50 × 50 μm ² ~ 1000 M transistors



CMS HL-LHC Track-trigger

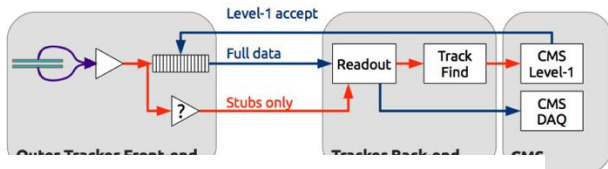
Needed to control trigger rate & threshold turn-on at high pile-up

Track stub compatible with $P_t > 2$ GeV

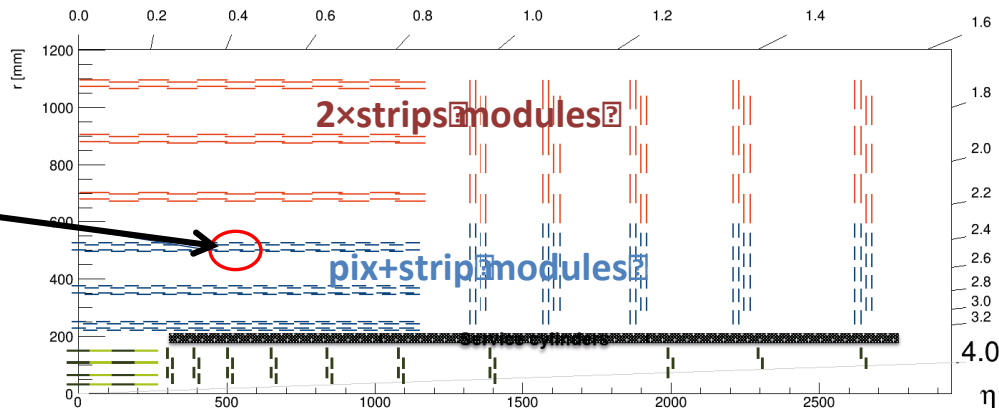


Stubs are processed in the back end to build L1 track primitives

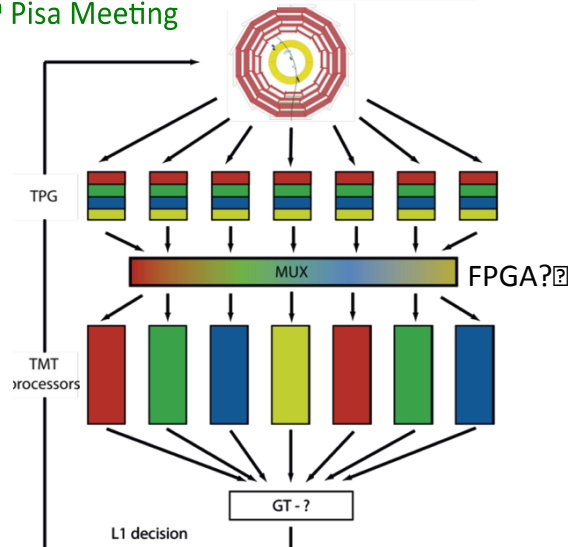
- @ 40 MHz (BX rate)
- @ 750 kHz (L1A rate)



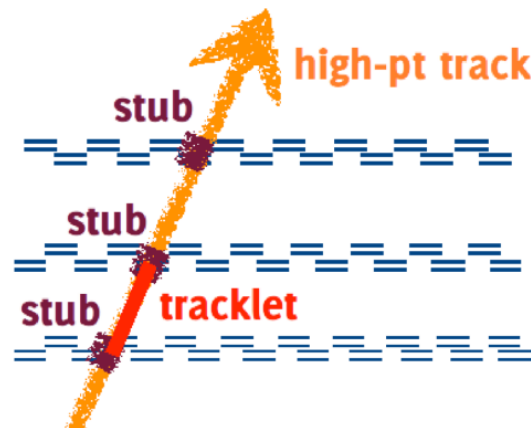
see e.g. D. Abbaneo, CERN PH seminar, F. Ravera 13th Pisa Meeting



Track matching with a 10^8 pattern database- Associative Memories



Time multiplexed trigger. Each processor deals with complete event

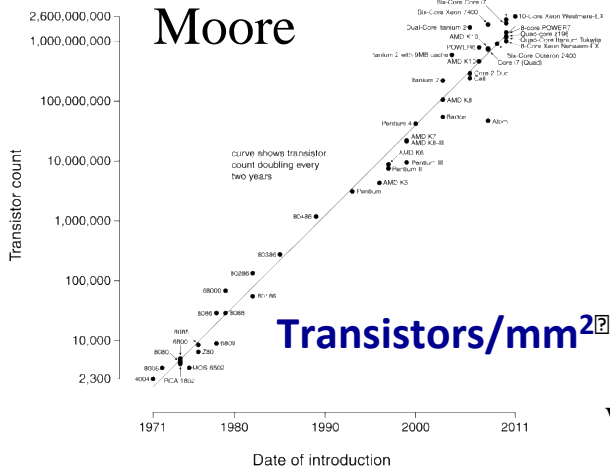


Track reconstruction seeded by pairs of stubs in adjacent layers

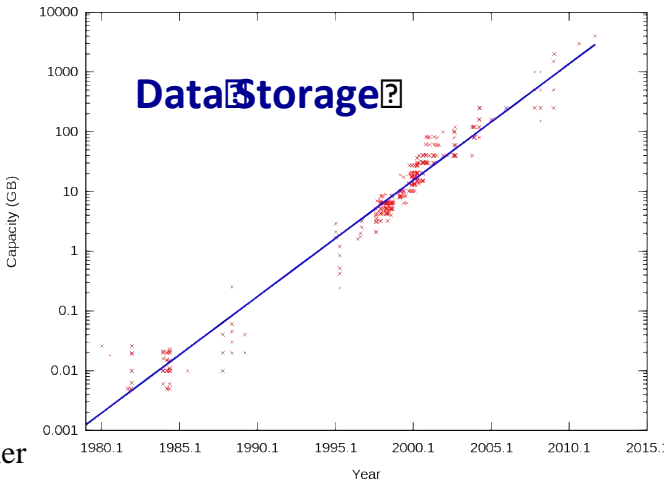
Will we need trigger at FCC-hh or even HL-LHC?

v. dangerous to predict further than a decade into the future
 (some predictions for LHC good : telecommunications links, CPU, some bad: optical links)

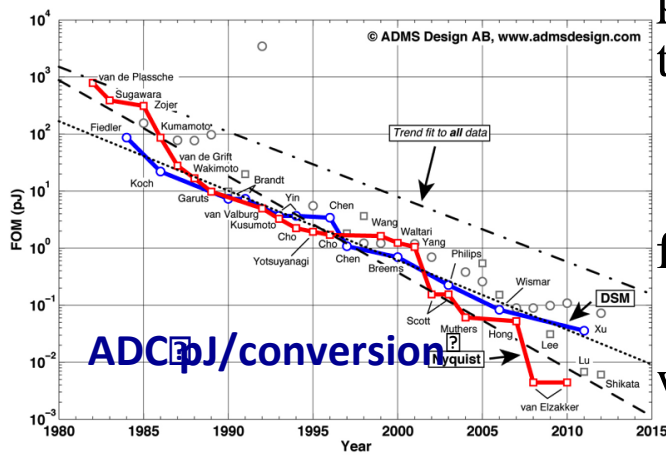
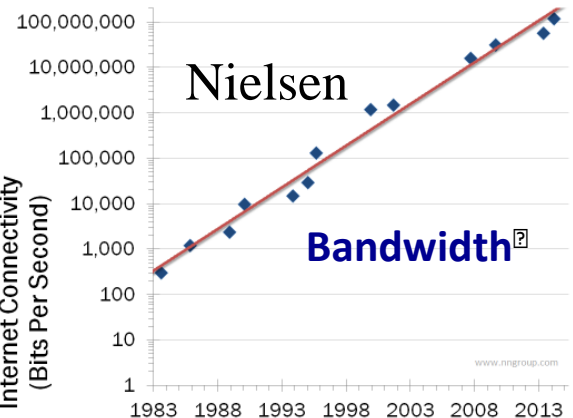
Microprocessor Transistor Counts 1971-2011 & Moore's Law



W.Riegler



Superficially promising doubling times (~ 2 years).
 Project to 2026 and hope for a factor 1000?



ALICE & LHCb already planning multi TB/s transmission off detector

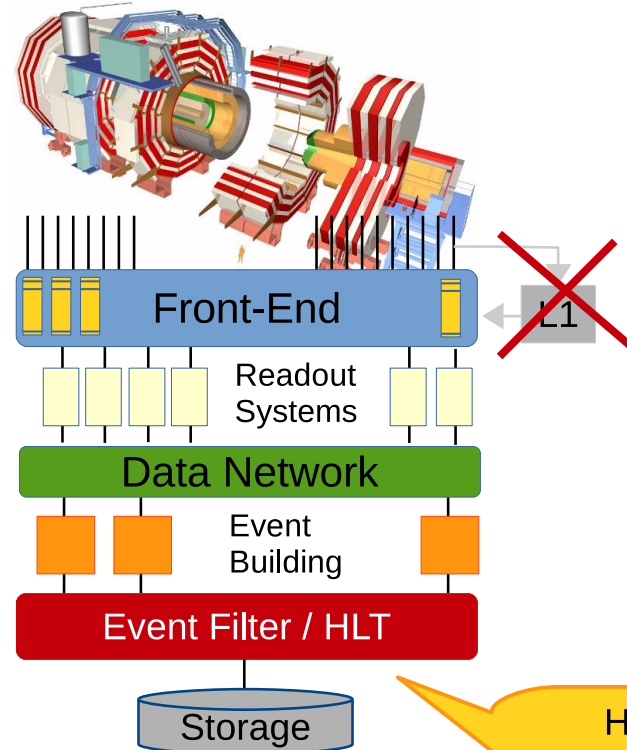
but for CMS II at HL-LHC, triggerless output rate would be 200TB/s

Triggerless DAQ?

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Assume 10Gb rad hard GBT + 400GB ethernet. 100TB SSD drives with 10GB/s/drive

$$40 \text{ MHz} * 5 \text{ MB/event} \\ = 200 \text{ TB/s} = 1600 \text{ Tb/s}$$



>100 times #links
as of today

Impossible!

160.000 x 10 Gb/s links (VL)

Rad hard links are a real issue

10 times more links than
LHCb is planning for Run-3

Maybe feasible

4000 x 400 Gb/s Ethernet

12 PB/min buffer

120 drives per
minute of buffer...

No problem

...but to achieve the throughput
with 10GB/s/drive → 20.000 drives

**Huge discrepancy of
storage vs bandwidth!**

HLT CPU:
400(rate)*3(pileup)
~1000x today

From Moore ~100x

Maybe with GPU/FPGA

Fatal problem is getting
data off detector
Rad-hard special links!
Material budget!!!!

Future Trackers: CMOS pixels

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See Norbert Vermes VCI Wien Feb 2016 for review

Hybrid:

 Monolithic
Active

 Developing MAPS for HL_LHC and beyond
challenge of rate & rad tolerance: HR/HV CMOS

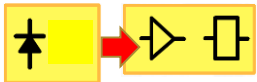
 fast charge collection of reasonably large signals (4000e-)
not too large a drift distance to avoid trapping effects

HV add-ons: increase voltage handling capacity

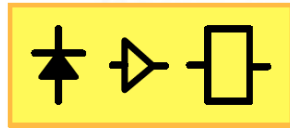
HR add-ons: higher resistivity Si wafers – depletion layer → DMAPS

130-180nm features: Rad hard processes, multiple nested wells

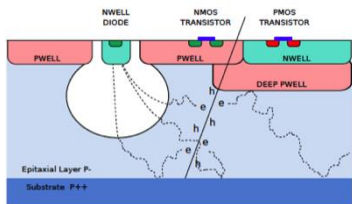
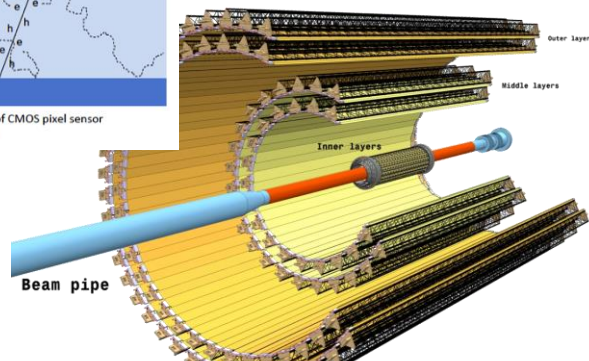
Backside processing: make backside contact after CMOS processes



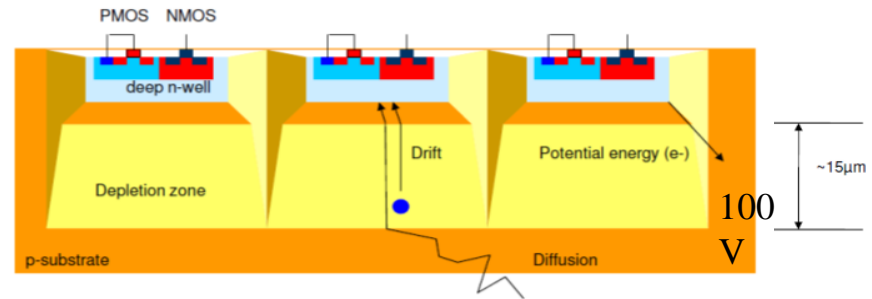
Bump bonding


 MAPS: lower material budget,
cost, power
+ better resolution

STAR, ALICE ITS upgrade


 Schematic cross-section of CMOS pixel sensor
(ALICE ITS Upgrade TDR)


Beam pipe

 ~ 10 m² 12.5 G pixel


: charge collection through drift space

improves speed & rad hardness

Many detailed variants, of which some reach tolerance of

 $5 \times 10^{15} n_{eq}/\text{cm}^2$ and 7MGy

---- no beam tests of large scale detectors yet

---> substantial ATLAS programme toward full-scale monolithic DMAPS devices

Particle flow & Imaging Calorimeters

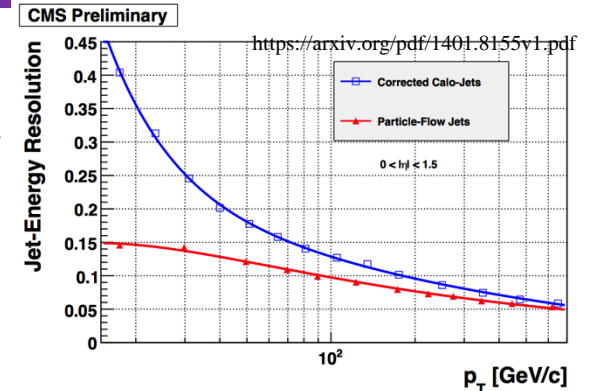
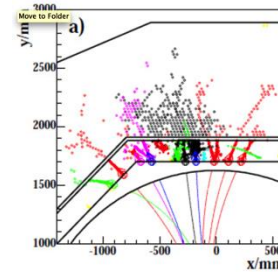
First successfully applied in ALEPH @LEP:

- much studied for linear collider applications eg CALICE

Re-construct entire event in detail including each jet: $E_{jet} = E_{track} + E_{\gamma} + E_{neutral}$

----> much improved E_{jet} res.

Excellent performance of Si Trackers suited to particle flow technique (70% of event info from tracks)



Jim Virdee, Oxford Sem Sep 2016

CMS HL_LHC simulation 140 pileup

Calorimeters for particle flow need:

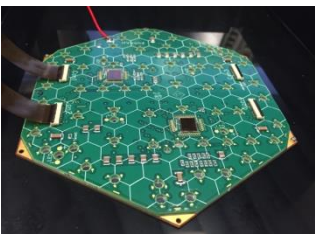
-granularity more than resolution,

-small Moliere radius in ECAL

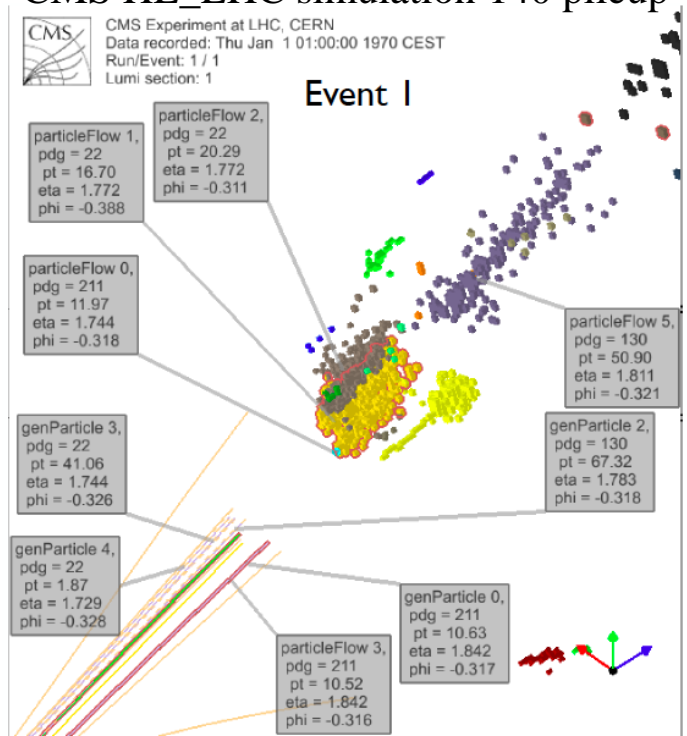
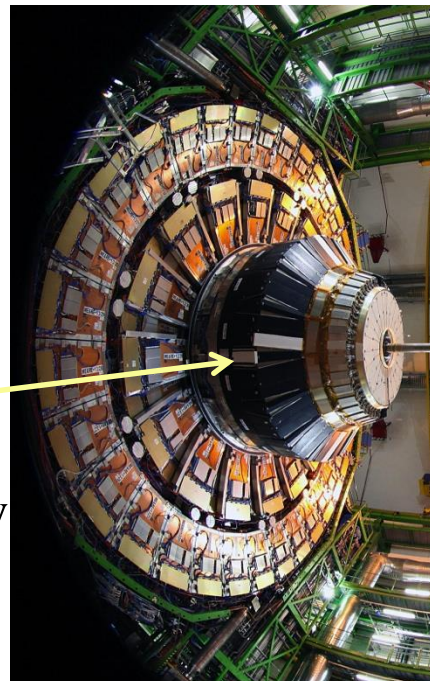
(shower sep) for jet core separation

+ high sampling density ---> Si + W

Radiation damage forces CMS to replace endcap calorimetry in LS3



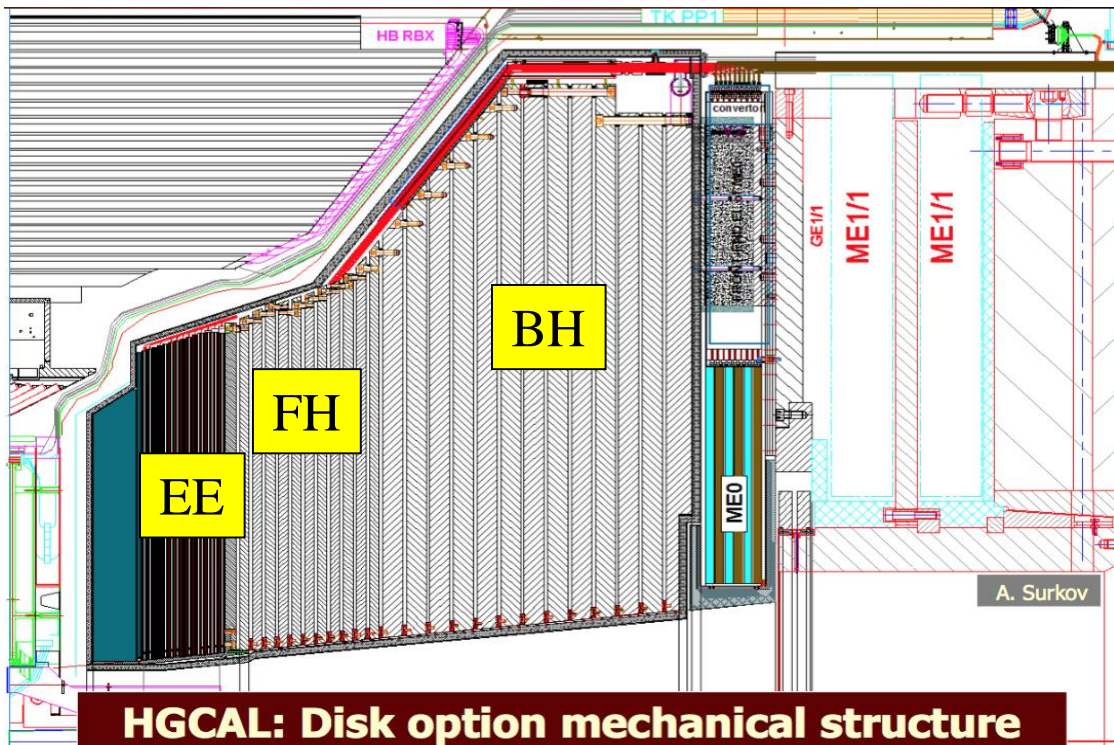
----> High Granularity Calorimeter



CMS EC Calorimeter : Some Current Thoughts

One of several mechanical options opened up by recent decision to use stainless steel absorber

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Jim Virdee, seminar Univ Oxford Sep 2016

Construction:

- Hexagonal Si-sensors built into modules.
- *Modules* with a W/Cu backing plate and PCB readout board.
- Modules mounted on copper cooling plates to make wedge-shaped *cassettes*.
- *Cassettes* inserted into *absorber* structures at integration site (CERN)

Key parameters:

- 593 m² of silicon
- 6M ch, 0.5 or 1 cm² cell-size
- 21,660 modules (8" or 2x6" sensors)
- 92,000 front-end ASICs.
- Power at end of life 115 kW.

System Divided into three separate parts:

EE – Silicon with tungsten absorber – 28 sampling layers – $25 X_0 + \sim 1.3 \lambda$

FH – Silicon with SS absorber – 12 sampling layers – 3.5λ

BH – Scintillator with SS absorber – 11 layers – 5.5λ

In this variant EE, FH and BH are maintained at -30°C : cold-warm transition at back of absorber challenge of new cooling distribution, thermal insulation & dew point control

HL-LHC: the relentless march of Silicon sensors:

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Production:

Particle physics community has experience with

a host of small producers:	10 - few 100 wafers per year
one dedicated large-scale producer:	1000-10,000 wafers per year

Now considering very large scale producers 50000 wafers *per week*

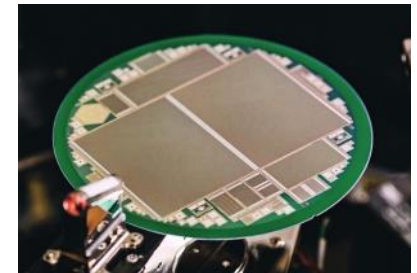
*to benefit from reduced costs and semiconductor industry
push towards 8" and maybe 12 " wafers*

Potential pathway to cheap & reliable mass-production

but

A completely new problem of prototyping & QA/QC

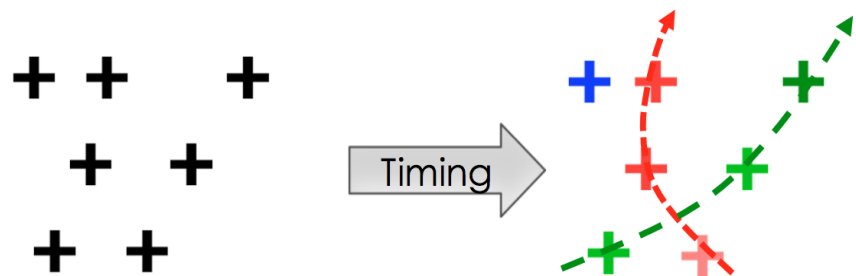
An entire tracker could be produced (right or wrong!) in a few days



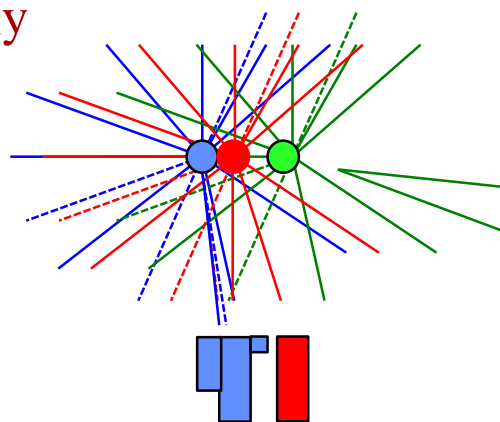
Previous experience suggests caution: long R & D to qualify ≥ 2 vendors for production
feedback as close to manufacturer as possible

4D tracking: the holy grail of fast timing

Pattern recognise only time-compatible points
reducing combinatorial options dramatically

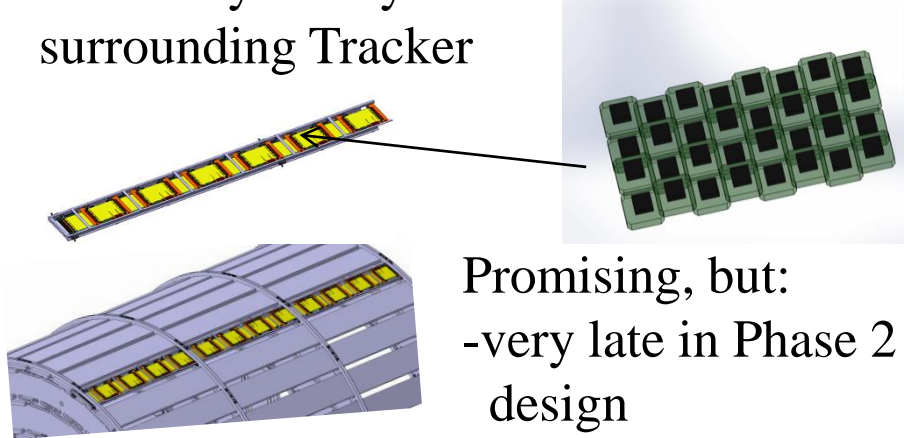


Powerful anti-pile-up weapon

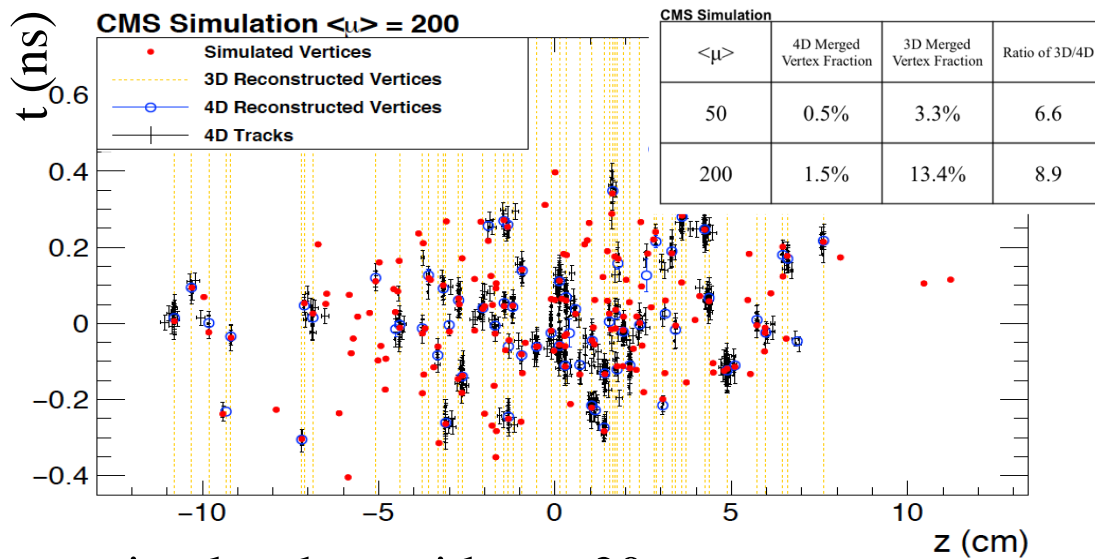


- prevent E_t^{miss} contamination by wrong (3d) merged vertex
- associate time-stamped jet or neutral to correct vertex & thus other components of same event.
- associate secondary vertex with right primary

Eg CMS investigating thin, MIP-sensitive LYSO crystal layer with SiPM readout surrounding Tracker



Promising, but:
-very late in Phase 2 design
-no deferral option



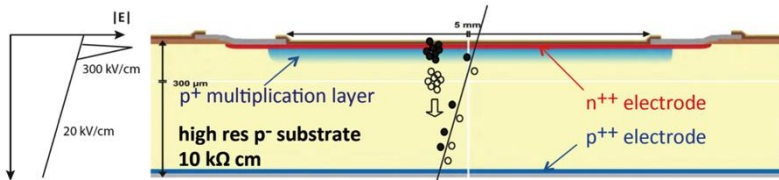
Other approaches to ~ 10ps timestamp?

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P. Allport, SWEPPS, August 2016

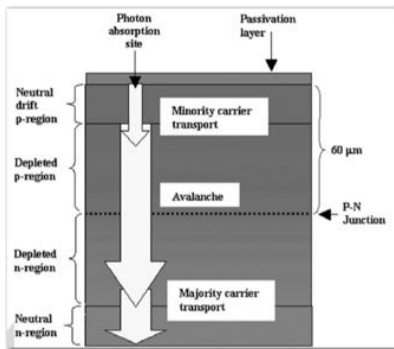
-Low Gain Avalanche Detector
thin p-implant near p-n junction

~ low gain APD



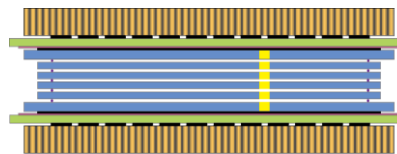
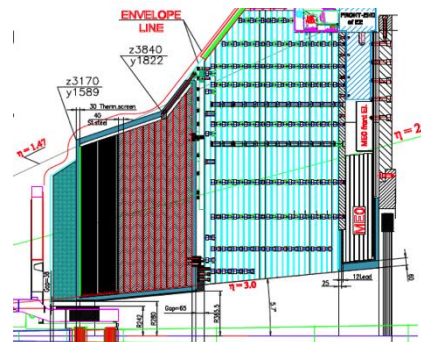
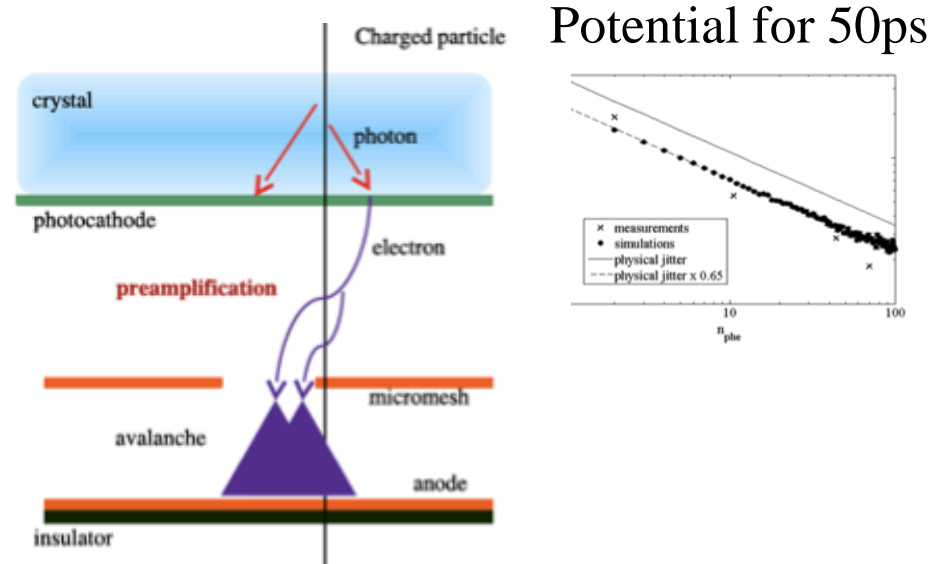
σ_t becomes dominated by slew-rate
minimise balance of thickness & gain.
integratable as a layer in Tracker? – if soon

-Deep depleted APD



-MCP-PMT, etc

crystal (Cerenkov radiator)+photocathode+Micromegas



Note that existing detectors in Phase II
Baseline achieve useful time res.

eg CMS HGCal simulated ~20ps
(> 20 MIPS seen by 5mm pads)

CMS barrel: 30ps target (neutrals)

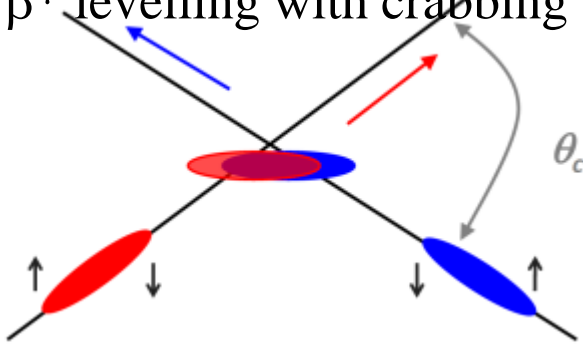
Muon system glass RPC stack: 100ps

The potential of crab cavities

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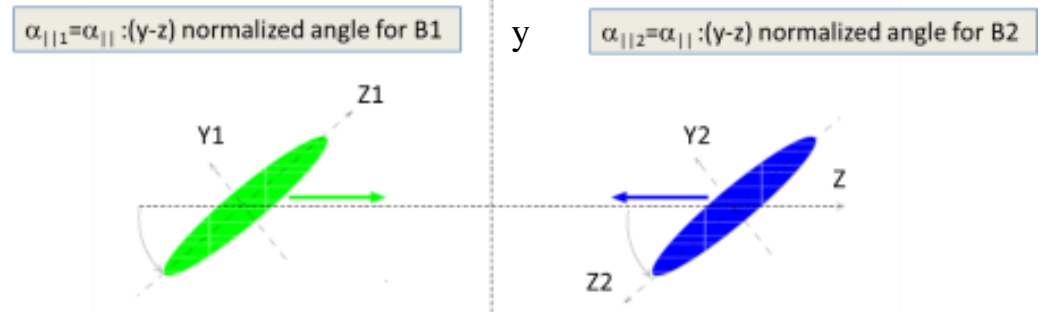
Stephane Fartouk, ECFA workshop, 2014

Plane of crossing angle
 β^* levelling with crabbing



45mm (150ps) rms luminous region
 1.2 vertices/mm @ mean pile-up 140
 need ~10ps time res to be useful

Parallel plane



Intriguing options for adjusting the
 shape of the luminous region in 4D
 with the full complement of crab cavities

Necessary hardware currently deferred to HL-LHC Phase 1, but note that

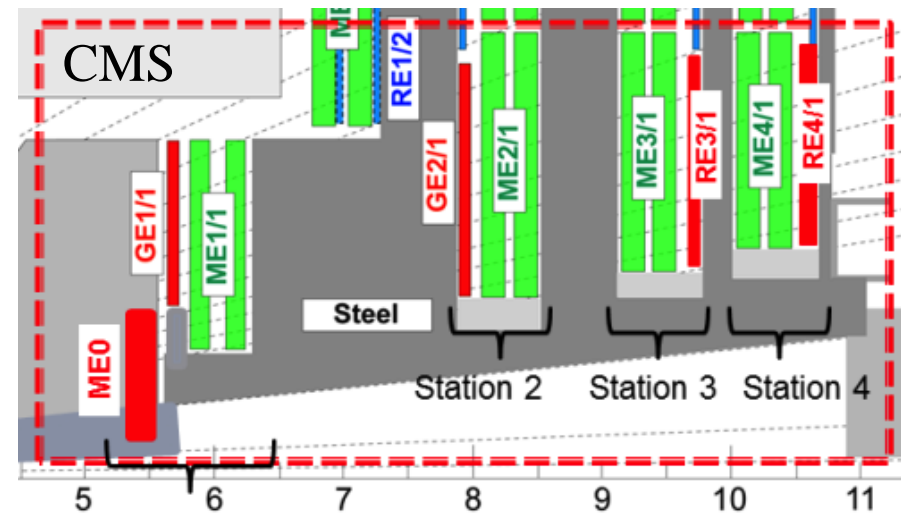
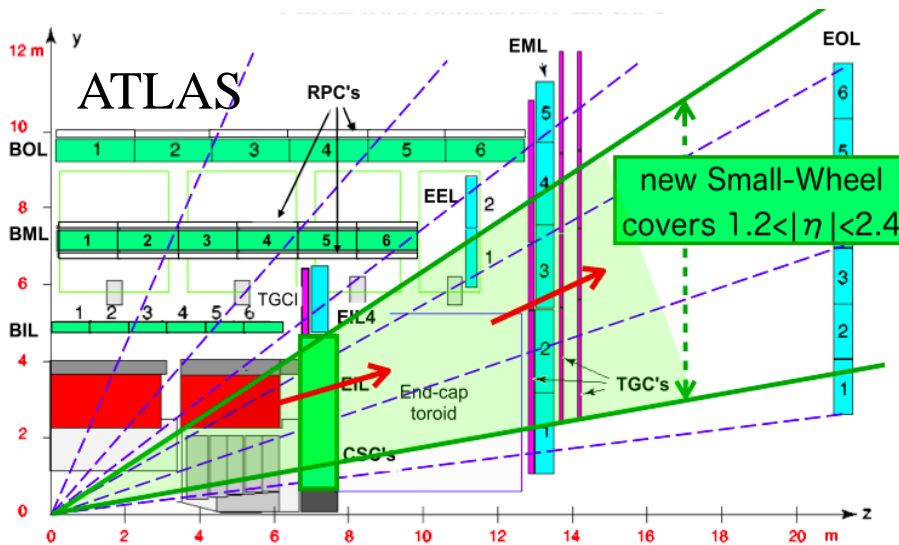
4-D tuning of luminous region shape + fast timing detectors = powerful anti-pile-up weapon

Muon detectors at HL-LHC

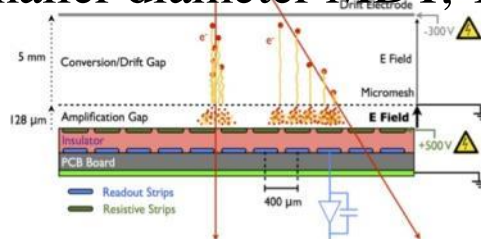
In the forward region, rates near limit, and pressure to extend max- η

New generation (micro-pattern) gaseous detectors (TGC's Micromegas, GEM's) offer a cost-effective solution for spatial resolution & improved timing.

Low ρ RPC's (bakelite/glass – multigap) look promising for detection+ time-stamp (100ps)



Smaller diameter MDT, TGC



- Triple GEM - 140 μm pitch, single mask and new assembly technique
- i RPC's - few kHz/cm² low- ρ Bakelite/Glass - multi-gap - thinner electrodes - higher gain FE - time resolution $\lesssim 100$ ps

Muon detectors

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Over most of the solid angle (except high η – next slide), existing ATLAS & CMS gas ionisation-based muon detection systems are expected to tolerate 3-4 fb⁻¹

-“time in environment” might be enough to cause unexpected degradation

humidity, HV insulator degradation, gas-structure interaction

-replace electronics becoming unreliable/un-maintainable

or incompatible with latency of revised trigger

-might need to shield against increasing ambient n backgrounds

- pressure to phase out release of gas mixture components with high GWP

(C₂H₂F₄, CF₄, SF₆) ---> recuperation systems

---> low GWP gas mixtures

unlikely signal (& possibly HV) characteristics matched to today's HV & FE

----> v major, possibly impractical, refit

Muon systems, having a large number of ~autonomous detectors, are labour-intensive to operate if the required >98% functional fraction is to be sustained.

who exactly will be willing (& able) to do this into the late 2030's??

FCC-hh detectors: start with blank page!

Most material from FCC-HH detector working group, W.Riegler & FCC Rome meeting

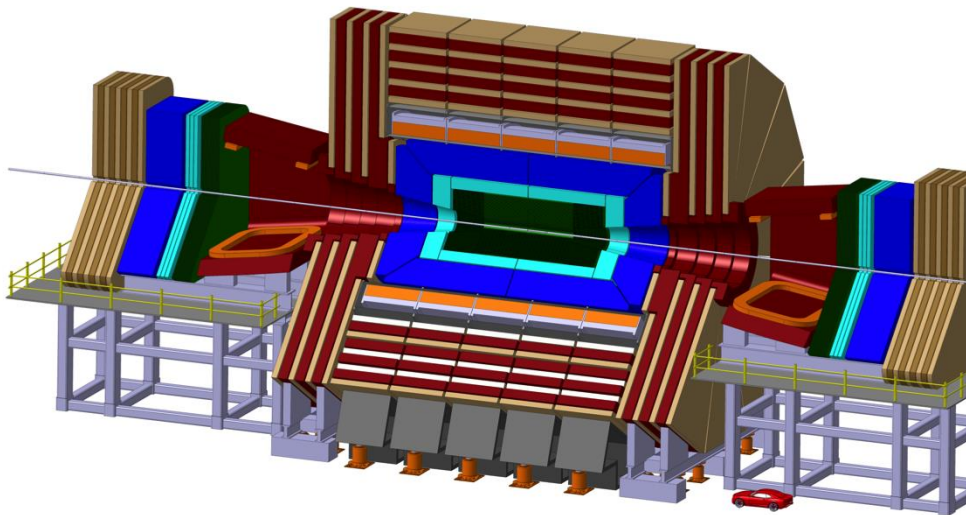
24

$$\frac{\Delta p_T}{p_T} \Big|_{reso.} = \frac{\sigma p_T}{0.3BL(\eta)^2} \sqrt{\frac{720}{N(\eta) + 4}}$$

$$\frac{\Delta p_T}{p_T} \Big|_{m.s.} = \frac{0.0136}{0.3BL(\eta)} \sqrt{\frac{x}{X_0}}(\eta)$$

First brainstorming:

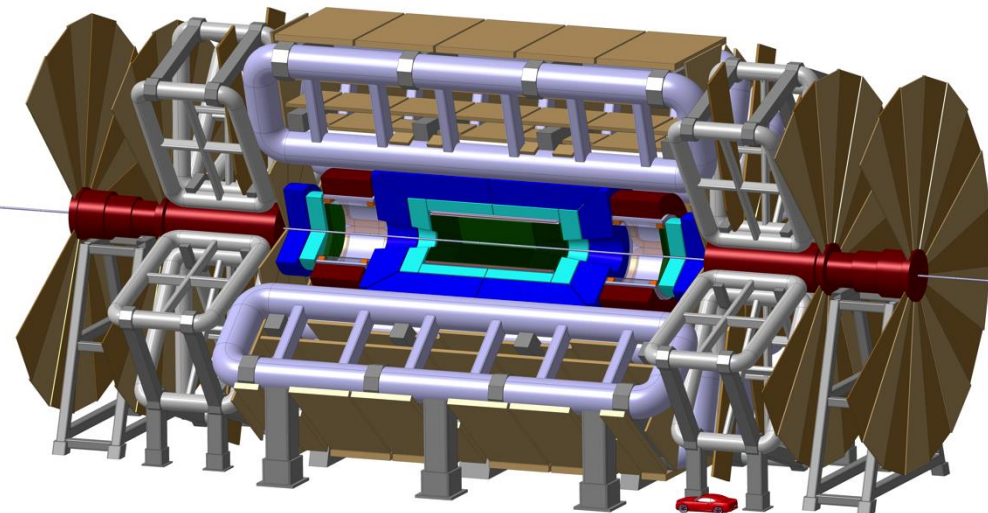
sensor performance same as today, calorimeter depth 12λ



CMS-like:

Forward dipoles extend effective tracking

Yoke fully containing return field is prohibitive: 120kton



ATLAS-like:

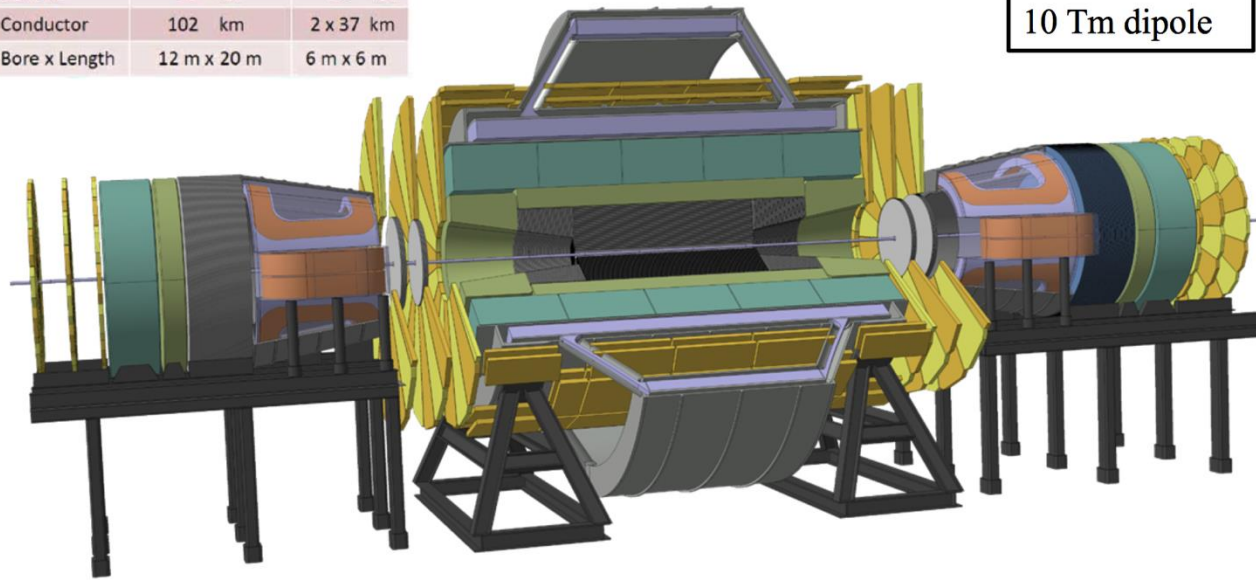
Standalone muon measurement of questionable value based on LHC experience ...and comes at v. high cost
Forward toroids awkward at inner radius

1st baseline:

Twin solenoid with opposite field directions(outer to to guide return flux of inner). Forward dipole system. Magnet system challenging mainly because of size & cancelling effect of outer coil field on inner coil field (inner actually a 9T solenoid).

	Twin Solenoid	Dipole
Stored energy	53 GJ	2 x 1.5 GJ
Total mass	6 kt	0.5 kt
Peak field	6.5 T	6.0 T
Current	80 kA	20 kA
Conductor	102 km	2 x 37 km
Bore x Length	12 m x 20 m	6 m x 6 m

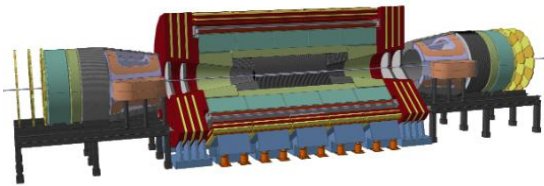
Twin solenoid
6 Tesla
12m bore
10 Tm dipole



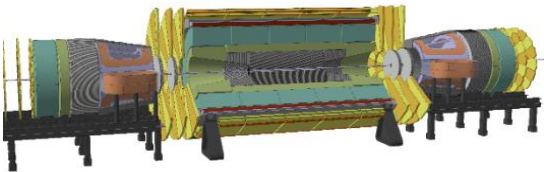
- ?????'s
- Construction Modularity
 - Shaft & cavern sizes
 - Mechanical support structure
 - Maintenance

27m diameter x 60m length: detector elements all feasible - dimensional scale-up from LHC
- Important to establish that this beast could be built: but it is a beast! Est magnet cost \$1000M!

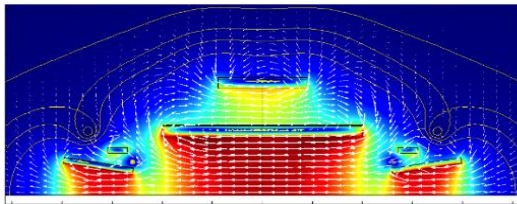
..evolutionary options:



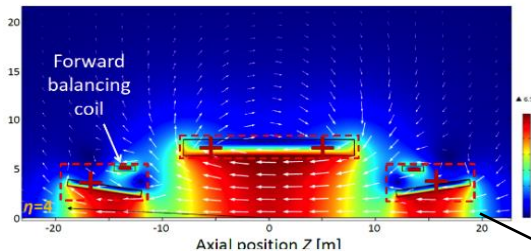
Single solenoid with “partial return yoke”
+ forward dipoles



Single solenoid with no return yoke + dipoles



Twin solenoid + balanced conical forward solenoids



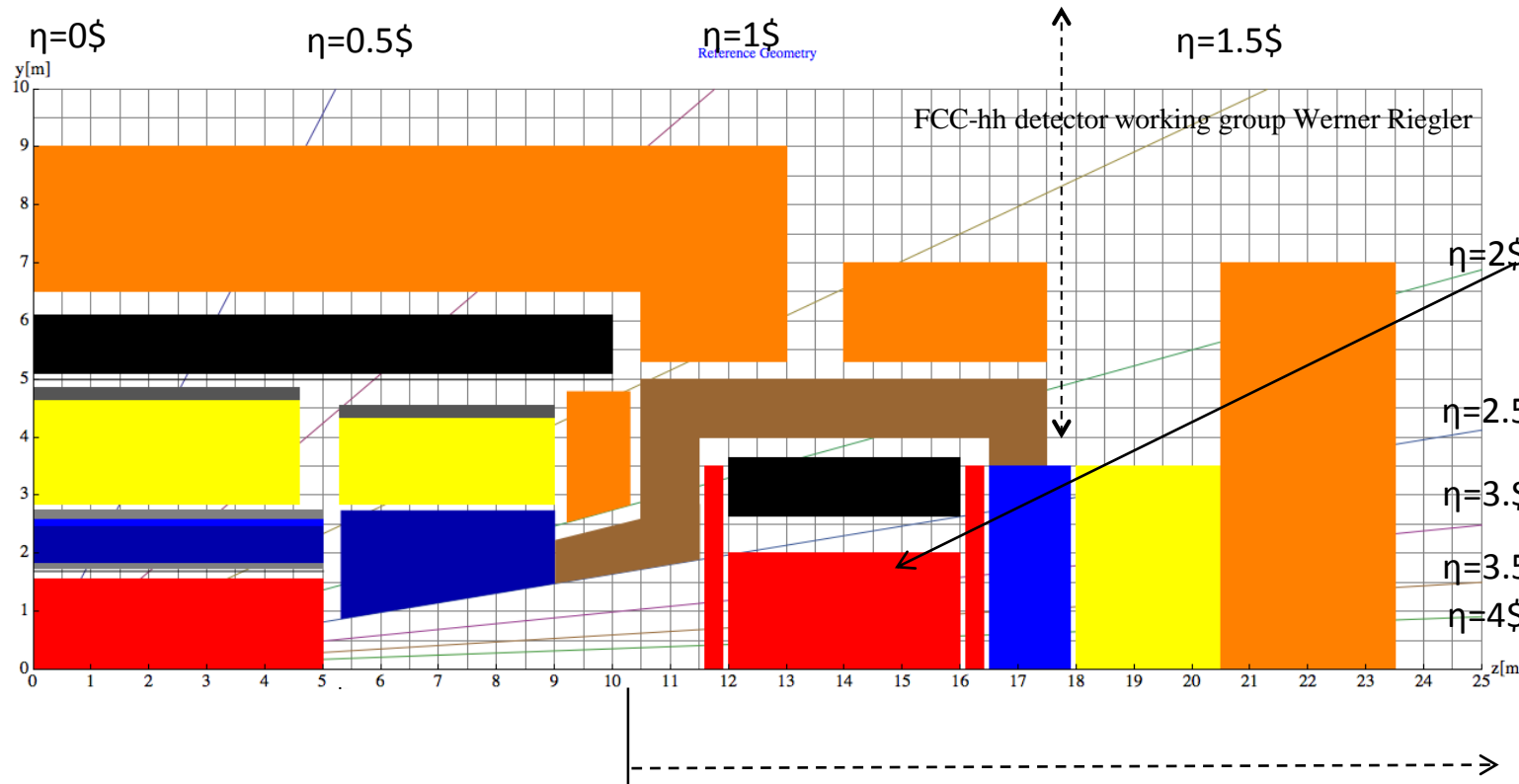
Single solenoid with no return yoke
+ balanced conical (or cylindrical) forward solenoids

Zeroing in on the next baseline

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No return yokes: large fringe fields extend throughout cavern ----> issues

Reduction in the central solenoid radius 6m ---> 5m: assumes improved detector point resolution (+ lower material budget).



Forward Solenoids:
 ~ same forward $\Delta p_T/p_T$ performance as the 10Tm dipoles.
 - smoother field continuity
 - lower backgrounds & cleaner shielding scenario.

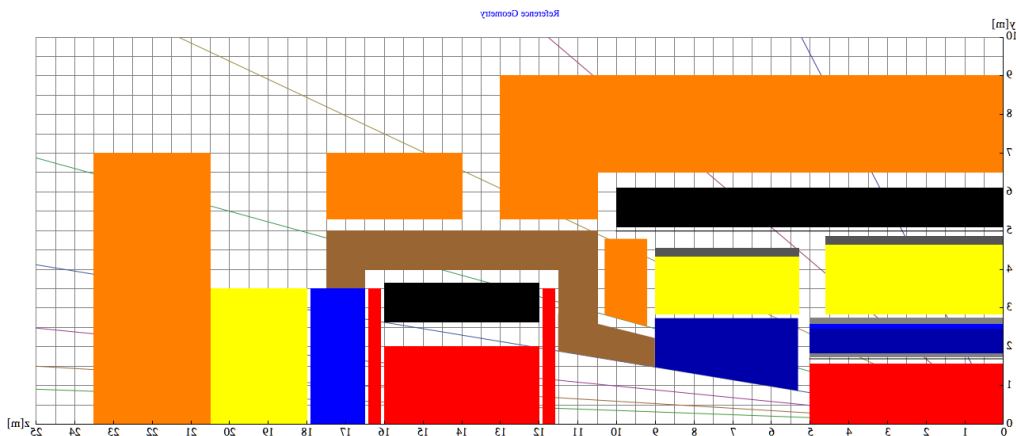
Maintenance scenario still cumbersome (9m x or 12m z movement of fwd system inc sc coil!)

Instrumentation solutions ---> Construction solutions

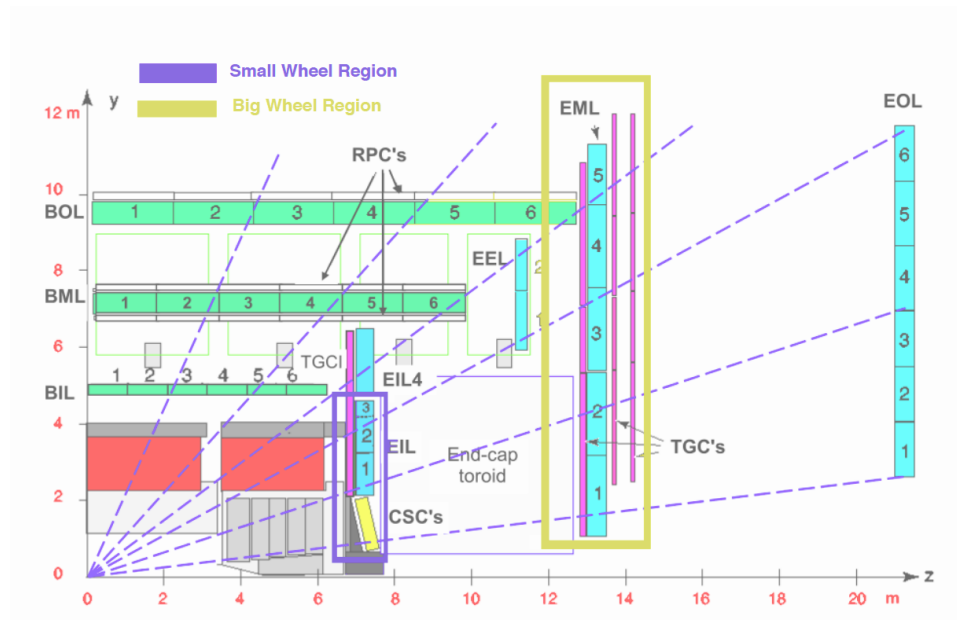
Required shaft size similar to ATLAS

Cavern dimensions: superficially also similar, strongly affected by maintenance scenarios

Uncontrolled return flux could give rise to many problems.....



FCC-hh Ref. enveloping radius 10m
Length 50m



ATLAS enveloping radius 12m
Length 44m

Instrumentation solutions ---> Construction solutions ?

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CMS Coil & ATLAS toroids



Preferred model would be worldwide modular construction

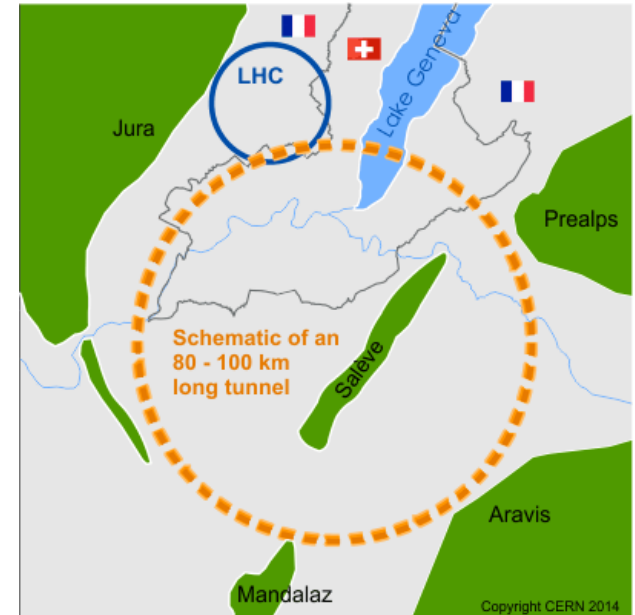
Feasibility for FCC expt dimensions??

Expt location/surface site should allow:

- Access for heavy, outsize & unusual loads

- Direct routing of large components to site from manufacturer.

- complete construction of large elements on site (surface or underground)



eg FCC-hh at CERN

Assuming GP expt sites diametrically opposite, both will need substantial facilities & autonomy.

Optimisation of expt dimensions has far-reaching consequences

Concluding Remarks

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Standard-model-like light Higgs is a conundrum for detector designers as well as theorists:

Future detectors have to :

- be optimised for precision Higgs & SM physics
- provide best sensitivity for new phenomena at high mass

HL-LHC is the known future, but the proposed detectors are not yet a done deal

65nm pixel readout

imaging calorimetry

mass industrialisation of Si wafer production?

- opportunities to test the technologies that could enable realistic solutions for FCC (at least from moderate radii outwards) and do precision physics in higher η regions

For the hypothetical future:

- high resolution , low mass, low power tracking over large volumes is critical
- compact calorimetry (perhaps imaging calorimeters) will help reduce magnet costs
- pile-up probably needs 2 solutions: 5ns bunch spacing in collider
 - ~10ps time-stamping of tracks, clusters & vertices
 - by detector (hopefully exploited already at HL-LHC)

HE-LHC: -could come much earlier than earliest projection for FCC

- close to the same rate/radiation tolerance challenge.